

Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Title ::

METHOD FOR

MANUFACTURING THIN

FILM INTEGRATED

CIRCUIT, AND ELEMENT

SUBSTRATE

Attorney Docket Number::

0756-7782

Total Drawing Sheets::

30

Small Entity?::

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Given Name::

Shunpei

Middle Name::

Family Name::

YAMAZAKI

Name Suffix::

City of Residence::

Setagaya

State or Province of Residence::

Tokyo

Country of Residence::

Japan

Street of mailing address::

c/o Semiconductor Energy

Laboratory Co., Ltd.

City of mailing address:: 398, Hase
Atsugi-shi
State or Province of mailing address:: Kanagawa-ken
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 243-0036

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Given Name:: Koji
Middle Name::
Family Name:: DAIRIKI
Name Suffix::
City of Residence:: Isehara
State or Province of Residence:: Kanagawa
Country of Residence:: Japan
Street of mailing address:: c/o Semiconductor Energy
Laboratory Co., Ltd.
398, Hase
City of mailing address:: Atsugi-shi
State or Province of mailing address:: Kanagawa-ken
Country of mailing address:: Japan
Postal or Zip Code of mailing address:: 243-0036

Correspondence Information

Correspondence Customer Number :: 31780
E-Mail address:: erobinson@riplo.com

Representative Information

Representative Customer Number:: 31780

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	National Stage	PCT/JP2005/001541	01/27/2005

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-031064	02/06/2004	Yes

Assignee Information

Assignee name:: Semiconductor Energy Laboratory Co., Ltd.

Street of mailing address:: 398 Hase

City of mailing address:: Atsugi-shi

State or Province of mailing address:: Kanagawa-ken

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 243-0036